



DATA SHEET

SURFACE MOUNT MULTILAYER CERAMIC CAPACITORS High Frequency Automotive Grade

NP0

I6 V TO 50 V 0.2 pF to 100 pF RoHS compliant & Halogen Free



YAGEO Phícomp

YAGEO Phicomp

Surface-Mount Ceramic Multilayer Capacitors High Frequency Automotive grade 2

15

<u>SCOPE</u>

This specification describes Automotive grade NPO series chip capacitors with lead-free terminations and used for automotive equipments.

APPLICATIONS

All general purpose applications Entertainment applications Comfort / security applications Information applications

FEATURES

- AEC-Q200 qualified
- MSL class: MSL I
- AC series soldering is compliant with J-STD-020D
- Halogen free epoxy
- RoHS compliant
- Reduce environmentally hazardous waste
- High component and equipment reliability
- The capacitors are 100% performed by automatic optical inspection prior to taping.

ORDERING INFORMATION - GLOBAL PART NUMBER

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value.

NP0

GLOBAL PART NUMBER

AQ <u>XXXX</u> <u>X</u> <u>X</u> <u>XXX</u> <u>X</u> B <u>X</u> <u>XXX</u> (1) (2) (3) (4) (5) (6) (7)

(I) SIZE - INCH BASED (METRIC)

0603 (1608)

(2) TOLERANCE

| 0.2pF to 2.0pF |
|---------------------------|
| $A = \pm 0.05 \text{ pF}$ |
| $B = \pm 0.1 \text{ pF}$ |
| C = ±0.25 pF |
| 2.1 pF to 5.0pF |
| $A = \pm 0.05 \text{ pF}$ |
| $B = \pm 0.1 \text{ pF}$ |
| C = ±0.25 pF |
| $D = \pm 0.5 \text{ pF}$ |
| 5.1pF to 9.9pF |
| $B = \pm 0.1 \text{ pF}$ |
| C = ±0.25 pF |
| $D = \pm 0.5 \text{ pF}$ |
| 10pF and over |
| $F = \pm 1\%$ |
| $G = \pm 2\%$ |
| $J = \pm 5\%$ |

(3) PACKING STYLE

- R = Paper/PE taping reel; Reel 7 inch
- P = Paper/PE taping reel; Reel 13 inch

(4) TC MATERIAL

NPO

(5) RATED VOLTAGE

- 7 = 16 V 8 = 25 V
- 9 = 50 V

(6) PROCESS

N = NP0

(7) CAPACITANCE VALUE

2 significant digits+number of zeros The 3rd digit signifies the multiplying factor, and letter R is decimal point Example: $121 = 12 \times 10^{1} = 120 \text{ pF}$

| Phícomp | | | Product specification | |
|---|------------------------------------|-----|-----------------------|----|
| Surface-Mount Ceramic Multilayer Capacitors | High Frequency Automotive grade | NP0 | 16 V to 50 V | 15 |

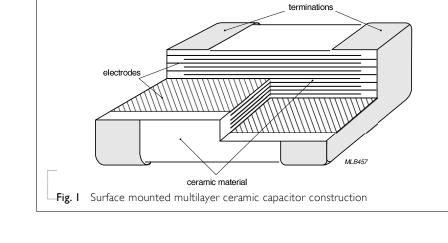
CONSTRUCTION

The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (Matte Sn). The terminations are leadfree. A cross section of the structure is shown in Fig. I.

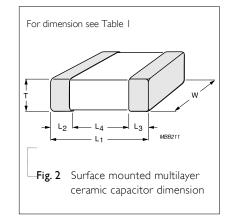
DIMENSION

Table I For outlines see fig. 2



| TYPE | L _I (mm) | W (mm) | T (MM) | L ₂ / min. | L ₃ (mm) max. | L ₄ (mm) min. |
|------|---------------------|-----------|-----------|--------------------------|-----------------------------|-----------------------------|
| 0603 | 1.6 ±0.10 | 0.8 ±0.10 | 0.8 ±0.10 | 0.20 | 0.60 | 0.40 |

OUTLINES





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CAPACITANCE RANGE & THICKNESS FOR NPO

| | s 0603 | <u>s inignite</u> | | <u> </u> | | | | |
|--------|---------|-------------------|---------|----------|--------|---------|---------|---------|
| CAP. | 0603 | | | | CAP. | 0603 | | |
| | 16 V | 25 V | 50 V | | | 16 V | 25 V | 50 V |
| 0.2 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | 9 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 |
| 0.3 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | 10 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 |
| 0.4 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | 12 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 |
| 0.5 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | 15 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 |
| 0.6 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | 18 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 |
| 0.7 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | 22 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 |
| 0.8 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | 27 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 |
| 0.9 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | 33 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 |
| 1.0 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | 39 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 |
| I.2 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | 47 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 |
| 1.5 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | 56 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 |
| 1.8 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | 68 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 |
| 2.0 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | 82 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 |
| 2.2 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | 100 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 |
| 2.4 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | | | | |
| 2.7 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | | | | |
| 3.0 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | | | | |
| 3.3 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | | | | |
| 3.6 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | | | | |
| 3.9 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | | | | |
| 4.0 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | | | | |
| 4.7 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | | | | |
| 5.0 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | | | | |
| 5.6 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | | | | |
| 6.0 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | | | | |
| 6.8 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | | | | |
| 7.0 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | | | | |
| 8.0 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | | | | | |
| 8.2 pF | 0.8±0.1 | 0.8±0.1 | 0.8±0.1 | - | | | | |

NOTE

I. Values in shaded cells indicate thickness class in mm

2. Capacitance value of non E-12 series is on request



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|--------------|---|------------------------------------|-----|-----------------------|----|
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THICKNESS CLASSES AND PACKING QUANTITY

| Table 13 | | | | | | |
|----------|----------------|-------------------|-------|-------------|-------|--------------|
| SIZE | THICKNESS | | Ø180 | MM / 7 INCH | Ø330 | MM / 13 INCH |
| CODE | CLASSIFICATION | QUANTITY PER REEL | Paper | Blister | Paper | Blister |
| 0603 | 0.8 ±0.1 mm | 8 mm | 4,000 | | 5,000 | |

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ELECTRICAL CHARACTERISTICS

NP0 DIELECTRIC CAPACITORS; NI/SIN TERMINATIONS

Unless otherwise specified, all test and measurements shall be made under standard atmospheric conditions for testing as given in 5.3 of IEC 60068-1:

- Temperature: 15 °C to 35 °C
- Relative humidity: 25% to 75%
- Air pressure: 86 kPa to 106 kPa

Before the measurements are made, the capacitor shall be stored at the measuring temperature for a time sufficient to allow the entire capacitor to reach this temperature.

The period as prescribed for recovery at the end of a test is normally sufficient for this purpose.

| Table I | 4 | |
|--------------|---|--|
| DESCRIPT | ION | VALUE |
| Capacitanc | e range | 0.2 pF to 100 µpF |
| Capacitanc | e tolerance | |
| NP0 | C < 10 _P F | ± 0.05 pF, ±0.1 pF, ±0.25 pF, ±0.5 pF |
| | C ≥ 10 pF | ±1%, ±2%, ±5% |
| Dissipation | factor (D.F.) | |
| NP0 | C < 30 _P F | \leq / (400 + 20C) |
| | C ≥ 30 pF | ≤ 0.1 % |
| Insulation r | resistance after 1 minute at U _r (DC) | $IR \ge 10 \text{ G}\Omega$ |
| | capacitance change as a function of temperature ire characteristic/coefficient): | |
| NP0 | | ±30 ppm/°C |
| Operating | temperature range: | |
| NP0 | | –55 °C to +125 °C |
| | | |



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Surface-Mount Ceramic Multilayer Capacitors High Frequency Automotive grade

SOLDERING RECOMMENDATION . .

| Table 15 | | | | | |
|---------------------|--------------|----------|----------|----------|-------------|
| SOLDERING METHOD | SIZE 0402 | 0603 | 0805 | 1206 | ≥ 1210 |
| Reflow | ≥0.1 µF | ≥ I.0 µF | ≥ 2.2 µF | ≥ 4.7 µF | Reflow only |
| Reflow/Wave | < 0.1 µF | < 1.0 µF | < 2.2 µF | < 4.7 µF | |

SOLDERING CONDITIONS

The lead free MLCCs are able to stand the reflow soldering conditions as below:

- Temperature: above 220 °C ٠
- Endurance: 95 to 120 seconds ٠
- Cycles: 3 times

The test of "soldering heat resistance" is carried out in accordance with the schedule of "MIL-STD-202F-method 210F", "The robust construction of chip capacitors allows them to be completely immersed in a solder bath of 270 °C for 10 seconds". Therefore, it is possible to mount MLCCs on one side of a PCB and other discrete components on the reverse (mixed PCBs). Surface Mount Capacitors are tested for solderability at 245 °C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds.

TESTS AND REQUIREMENTS

| TEST | TEST METH | IOD | PROCEDURE | REQUIREMENTS |
|------------------------------|---------------------|-------|--|----------------------------------|
| Mounting | IEC 60384- 21/22 | 4.3 | The capacitors may be mounted on printed-circuit boards or ceramic substrates | No visible damage |
| Capacitance | IEC 60384- 21/22 | 4.5.I | Class I: At 20 °C, 24 hours after annealing $f = 1 \text{ MHz}$ for $C \le 1 \text{ nF}$, measuring at voltage 1 V _{rms} at 20 °C f = 1 KHz for $C > 1 nF$, measuring at voltage 1 V _{rms} at 20 °C | Within specified tolerance |
| Dissipation Factor (D.F.) | IEC 60384- 21/22 | 4.5.2 | Class I: At 20 °C, 24 hours after annealing $f = 1 \text{ MHz}$ for $C \le InF$, measuring at voltage 1 V _{rms} at 20 °C f = 1 KHz for $C > InF$, measuring at voltage 1 V _{rms} at 20 °C | In accordance with specification |
| Insulation Resistance | IEC 60384- 21/22 | 4.5.3 | At U _r (DC) for 1 minute | In accordance with specification |

| TEST | TEST METHO |) PROCE | DURF | REQUIREMENTS |
|---------------------------------|------------|---|---|---|
| Temperature coefficient | 4. | 5 Capacita the follo The cap min at e Step a b c d e (1) Clas Temper formula Temp, C C1: Cap C2: Cap Δ T: 100 (2) Clas Capacita formula Δ C = $\frac{C}{2}$ | ance shall be measured by the steps shown in wing table. acitance change should be measured after 5 ach specified temperature stage. Temperature(°C) 25±2 Lower temperature±3°C 25±2 Upper Temperature±2°C 25±2 s I ature Coefficient shall be calculated from the as below Coefficient = $\frac{C2 - CI}{CI \times \Delta T} \times 10^6$ [ppm/°C] acitance at step c acitance at 125°C 0°C(=125°C-25°C) | <general purpose="" series=""> Class I:</general> Δ C/C: ±30ppm |
| High Temperature Exposure | AEC-Q200 3 | | ered ; 1000hours @ T=150° C ement at 24±2 hours after test conclusion. | No visual damage Δ C/C : Class I: NPO: within ±0.5% or 0.5 pF whichever is greater |
| Temperature Cycling | AEC-Q200 4 | 24 ±1 h 1000 cy 30 minu | litioning; 10 °C for 1 hour, then keep for ours at room temperature cles with following detail: tes at lower category temperature tes at upper category temperature | No visual damage ΔC/C Class I : NP0: Within ±1% or 0.5pF, whichever is greater. |

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Product specification

16 V to 50 V

NP0

| YAGEO Product specific | |
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| TEST | TEST METHOD | PROCEDURE | REQUIREMENTS |
|------------------------|--|--|--|
| Moisture Resistance | AEC-Q200 6 | T=24 hrs/per cycle; 10 continuous cycles unpowered. Measurement at 24 \pm 2 hours after test condition. | No visual damage |
| | | | $\Delta C/C$ NP0: Within ±3% or 3 pF, whichever is greater |
| | | | D.F. Within initial specified value IR NP0: \geq 10,000 M Ω |
| Fig. 4 Moisture | b5 DITIO 60 A ORY 55 24 HOU 55 45 40 UNCONT 35 45 10 35 20 INITIAL 15 55 0 5 0 5 -10 5 -10 9 9 10 9 10 | | STEP 7 |
| Biased Humidity | AEC-Q200 7 | I. Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for 24 ±1 hour at room temp | No visual damage after recovery |
| | | Initial measure: Parameter: IR Measuring voltage: 1.5V ± 0.1 VDC Note: Series with 100 KΩ & 6.8 KΩ Test condition: 85 °C, 85% R.H. connected with 100 KΩ resistor, applied 1.5V/U_r for 1,000 hours. Recovery: Class1: 6 to 24 hours Class2: 24 ±2 hours | Initial requirement: Class I: - Connected to 100 K Ω : C ≤ 10 nF: 1.R ≥ 10,000 M Ω or C > 10 nF: (1.R-100 K Ω) × C ≥ 100s. - Connected to 6.8 K Ω : C ≤ 10 nF: 1.R ≥ 10,000 M Ω or C > 10 nF: (1.R-6.8 K Ω) × C ≥ 100s. |
| | | 5. Final measure: IR | Final measurement: The insulation resistance shall be |

The insulation resistance shall be greater than 0.1 time initial value.

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REQUIREMENTS TEST TEST METHOD PROCEDURE **Operational Life** AEC-Q200 8 No visual damage I. Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for $\Delta C/C$ 24 ±1 hour at room temp NPO: Within ±2% or 1 pF, whichever 2. Initial measure: is greater Spec: refer to initial spec C, D, IR 3. Endurance test: D.F. Specified stress voltage applied for 1,000 hours: NP0: $\leq 2 \times$ specified value. Applied 2.0 \times U_r for general products IR 4. Recovery time: 24 ±2 hours NP0: \geq 4,000 M Ω or IR \times C_r \geq 40s 5. Final measure: C, D, IR whichever is less Note: If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitor shall be preconditioned according to "IEC 60384 4.1" and then the requirement shall be met. **External Visual** AEC-Q200 9 Any applicable method using × 10 magnification In accordance with specification Physical 10 AEC-Q200 Verify physical dimensions to the applicable device In accordance with specification Dimension specification. Mechanical AEC-Q200 13 $\Delta C/C$ Three shocks in each direction shall be applied along Shock NP0: Within ±0.5% or 0.5 pF, the three mutually perpendicular axes of the test whichever is greater specimen (18 shocks) Peak value: 1,500 g's Duration: 0.5 ms D.F. Velocity change: 15.4 ft/s Within initial specified value Waveform: Half-sin IR Within initial specified value Vibration AEC-Q200 14 $\Delta C/C$ 5 g's for 20 minutes, 12 cycles each of 3 orientations. NP0: Within ±0.5% or 0.5 pF, Note: whichever is greater Use 8'' \times 5'' PCB. 0.31'' thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. D.F: meet initial specified value Test from 10-2000 Hz. IR meet initial specified value Resistance to AEC-Q200 15 Precondition: 150 +0/-10 °C for 1 hour, then keep for Dissolution of the end face plating Soldering Heat 24 ±1 hours at room temperature shall not exceed 25% of the length of the edge concerned Preheating: for size ≤ 1206: 120 °C to 150 °C for 1

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|--------------|---|------------------------------------|-----|--------------|----|
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| TEST | TEST METH | IOD | PROCEDURE | REQUIREMENTS |
|------------------|-----------|-----|--|---|
| | | | minute | ΔC/C |
| | | | Preheating: for size >1206: 100 °C to 120 °C for 1 minute and 170 °C to 200 °C for 1 minute | Class1: NP0: Within ±1% or 0.5 pF, |
| | | | Solder bath temperature: 260 ±5 °C | whichever is greater. |
| | | | Dipping time: 10 ±0.5 seconds | |
| | | | Recovery time: 24 ±2 hours | D.F. within initial specified value |
| | | | | IR within initial specified value |
| Thermal Shock | AEC-Q200 | 16 | I. Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for 24 \pm 1 hour at . | No visual damage |
| | | | room temp | ΔC/C |
| | | | 2. Initial measure: | NP0: Within ±1% or 1 pF, whichever |
| | | | Spec: refer to initial spec C, D, IR | is greater |
| | | | 3. Rapid change of temperature test: | |
| | | | NP0: -55 °C to +125 °C; 300 cycles | D.F: meet initial specified value |
| | | | 15 minutes at lower category temperature; 15 minutes at upper category temperature. | IR meet initial specified value |
| | | | 4. Recovery time: | |
| | | | Class I : 6 to 24 hours | |
| | | | Class2: 24 ±2 hours | |
| | | | 5. Final measure: C, D, IR | |
| ESD | AEC-Q200 | 17 | Per AEC-Q200-002 | A component passes a voltage level if all components stressed at that voltage level pass. |
| Solderability | AEC-Q200 | 18 | Preheated to a temperature of 80 °C to 140 °C and maintained for 30 seconds to 60 seconds. | The solder should cover over 95% of the critical area of each termination. |
| | | | Test conditions for lead containing solder alloy | |
| | | | Temperature: 235 ±5 °C | |
| | | | Dipping time: 2 ± 0.2 seconds | |
| | | | Depth of immersion: 10 mm | |
| | | | Alloy Composition: 60/40 Sn/Pb | |
| | | | Number of immersions: I | |
| | | | Test conditions for lead-free containing solder alloy | |
| | | | Temperature: 245 ±5 °C | |
| | | | Dipping time: 3 ±0.3 seconds | |
| | | | Depth of immersion: 10 mm | |
| | | | Alloy Composition: SAC305 | |
| | | | Number of immersions: 1 | |
| Electrical | AEC-Q200 | 19 | Parametrically test per lot and sample size | ΔC/C |
| Characterization | | | requirements, summary to show Min, Max, Mean and | Class I: |
| | | | Standard deviation at room as well as Min and Max operating temperatures. | NP0: ±30 ppm/°C |
| | | | Class I: | |
| | | | NP0: -55 °C to +125 °C | |
| | | | Normal temperature: 20 °C | |

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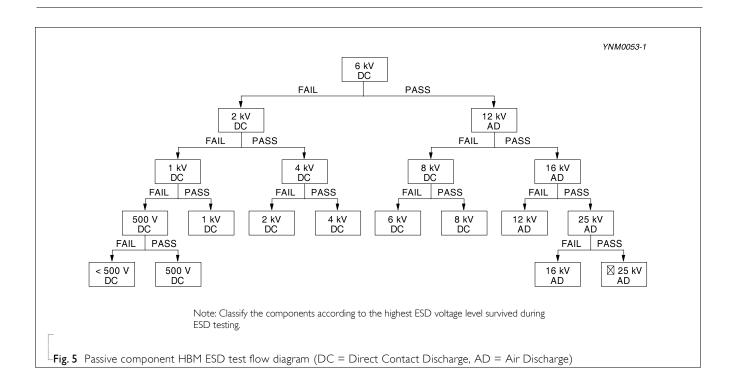
Surface-Mount Ceramic Multilayer Capacitors High Frequency Automotive grade

Product specification $\frac{12}{15}$

| TEST | TEST METH | IOD | PROCEDURE | REQUI | REMEN | ITS | |
|----------------------|-------------------|-----|--|--|---|---|--|
| Board Flex | w P re C | | Part mounted on a 100 mm X 40 mm FR4 PCB board, which is 1.6 ±0.2 mm thick and has a layer-thickness 35 µm ± 10 µm. Part should be mounted using the following soldering reflow profile. Conditions: Class I: Bending 3 mm at a rate of 1 mm/s, radius jig 340 mm | No visible damage $\Delta C/C$ Class I : NP0: Within ±1% or 0.5 pF, whichever is greater | | | |
| | | | Test Substrate: | | Dimen | sion(m | m) |
| | | | <mark> ↔ b</mark> 04.5 ™ | Туре | а | b | с |
| | | | | 0201 | 0.3 | 0.9 | 0.3 |
| | | | | 0402 | 0.4 | 1.5 | 0.5 |
| | | | | 0603 | 1.0 | 3.0 | 1.2 |
| | | | | 0805 | 1.2 | 4.0 | 1.65 |
| | | | +==+ | 1206 | 2.2 | 5.0 | 1.65 |
| | | | 100 | 1210 | 2.2 | 5.0 | 2.0 |
| | | | unit: mm | 1808 | 3.5 | 7.0 | 3.7 |
| Terminal Strength | AEC-Q200 | 22 | With the component mounted on a PCB obtained with the device to be tested, apply a 17.7N (1.8Kg) force to the side of a device being tested. This force shall be applied for 60+1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested. * Apply 2N force for 0402 size. | be empl mechani body, te junction. Before, o | oyed fo ical inte rminals during a hall con nents st | or inspe grity of and bo and afte nply wi | or greater m ction of the the device ody/terminal er the test, t th all electri this |
| Beam Load Test | AEC-Q200 | 23 | Place the part in the beam load fixture. Apply a force until the part breaks or the minimum acceptable force level required in the user specification(s) is attained. | ≤ 0805 Thicknes Thicknes ≥ 1206 Thicknes Thicknes | ss ≤ 0.5 ss ≥1.25 | mm: 81 5 mm: 5 | N 54N |
| Voltage Proof | | | Specified stress voltage applied for 1~5 seconds Ur ≤ 100 V: series applied 2.5 Ur 100 V < Ur ≤ 200 V series applied (1.5 Ur + 100) 200 V < Ur ≤ 500 V series applied (1.3 Ur + 100) Ur > 500 V: 1.3 Ur Ur ≥ 1000 V: 1.2 Ur Charge/Discharge current is less than 50 mA | No brea | - Ikdown | or flasl | nover |

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|-------|-------------------|----------------------------|------------------------------------|-----|--------------|----|--|
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| | | | | | | | |
| | | | | | | | |
| TEST | | | | | | | |

| TEST | TEST METHOD | PROCEDURE | REQUIREMENTS |
|------|-------------|---|--|
| ESR | | Measuring frequency: 1 \pm 0.2GHz at room | $0.2pF \le C \le IpF: 350m\Omega / Cmax$ |
| | | temperature. | $IpF < C \leq 5pF: 300m\Omega$ max |
| | | | $5pF < C \leq 10pF : 250m\Omega$ max |
| | | | C : Nominal cap (pF) |
| | | Measuring frequency: 500 \pm 50MHz at room temperature. | $10pF < C \leq 100pF$:400m Ω max |



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|--------------|---|------------------------------------|--------------------------|--------------|----|--|--|
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| | | | | | | | |

<u>REVISION HISTORY</u>

| REVISION | DATE | CHANGE NOTIFICATION | DESCRIPTION |
|-----------|---------------|---------------------|-------------|
| Version 0 | Dec. 14, 2018 | - | - New |
| | | | |

| YAGEO | Phicomp | | Produ | |
|-------|---|----------------|-------|------------|
| | Surface-Mount Ceramic Multilaver Canacitors | High Frequency | NP0 | 16 V to 50 |

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